

# Short pulse laser milling effects on surface integrity

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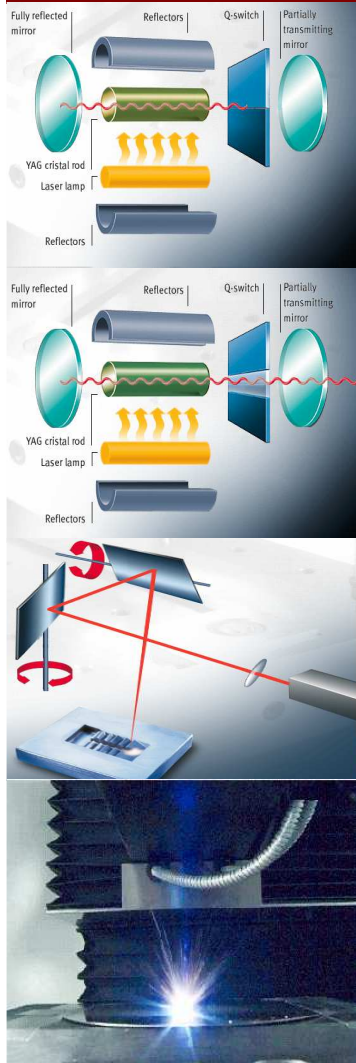


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# Presentation Outline

- Overview
- Process description
- Experiments & Results
- Conclusions



**LUMERA LASER**

## New: "SUPER RAPID"

- Proven and reliable concept, keeps RAPID benefits, with **additional amplifier** for higher output power

- High IR Power: > 8W @ 500 kHz (Single Pulse)
- Efficient harmonic generation ( $2\omega$ ,  $3\omega$ ,  $4\omega$ )

**Launched on Photonics West 2006**

*LASE: Commercial and Biomedical Applications of Ultrafast Lasers VI 2006 53 (55)*

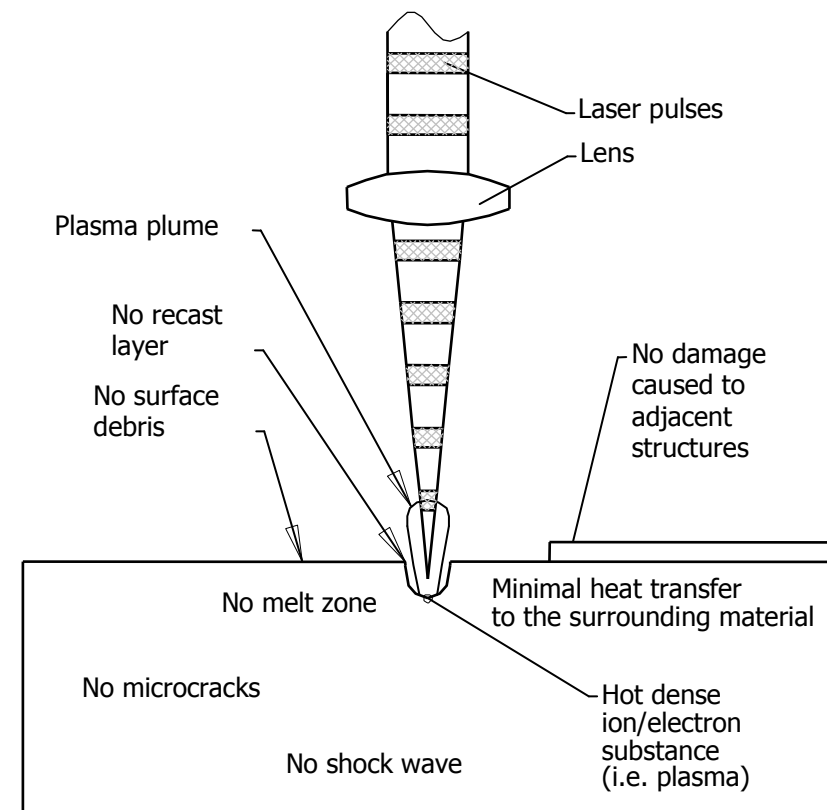
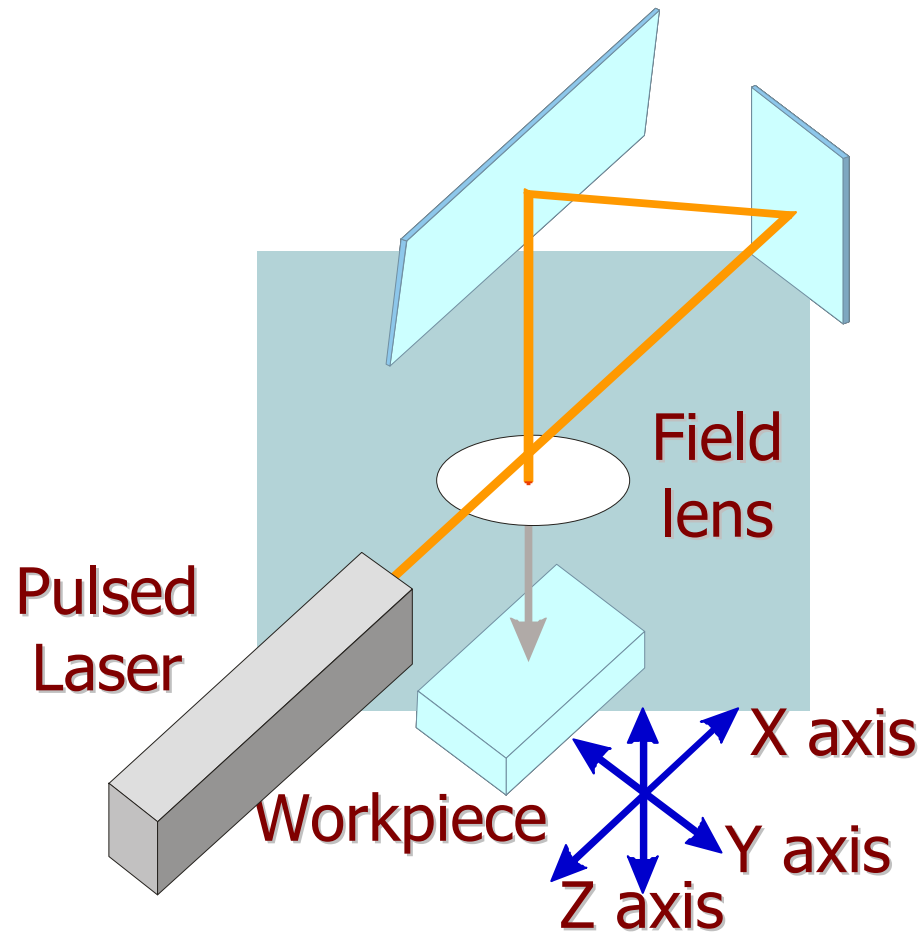
Pictures courtesy of Lasertech

Picture courtesy of Lumera

Short pulse laser milling effects on surface integrity



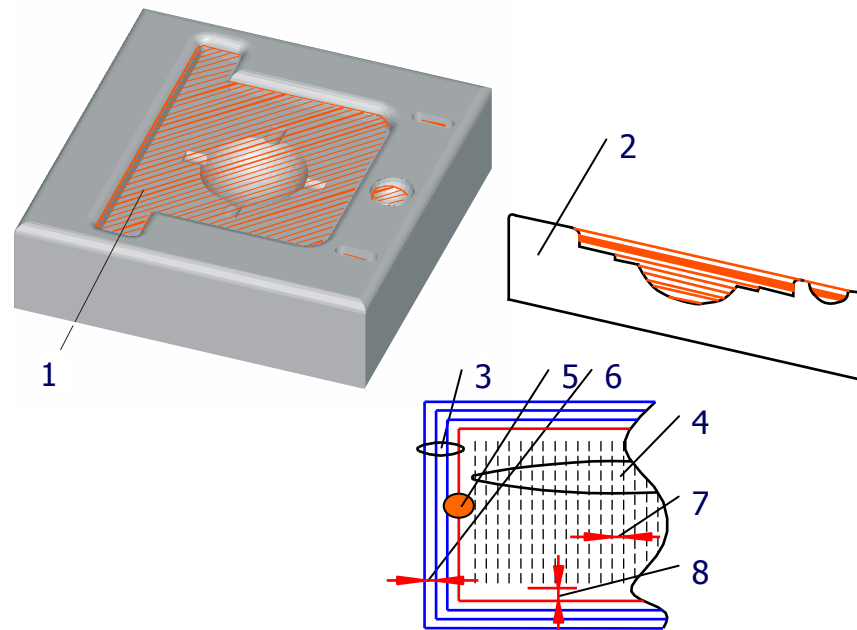
# Process description



Femto and picosecond laser ablation

Short pulse laser milling effects on surface integrity

# Process description



## Material removal in the laser milling process

1. cavity with a hatched slice
2. cross-section of the cavity with slices
3. border cuts
4. hatching cuts
5. laser spot
6. border cut track displacement (step-over)
7. hatch track displacement (step-over)
8. distance between the end of the hatch line and the innermost border cut

Short pulse laser milling effects on surface integrity

A series of experiments were conducted to assess the impact of the laser pulse duration on surface integrity. Two main effects were studied, in particular :

- **changes in material microstructure and**
- **surface quality**

by carrying out metallographic and surface profile analyses. In particular, to estimate the thermal load exercised on the substrate, the processed areas were analysed for **phase transformations** and changes in the **grain structure**.

EXPERIMENTS steps

- **Familiarisation with the material**
- **Machining of a series of 1 x 1 mm fields.**
- **Analysis**

The experiments were conducted on a BS EN ISO 4957 - X40CrMoV5-1 annealed tool steel work piece (0.35% C, 1% Si, 5% Cr, 1.4% Mo, 1% V). This material was selected because it is commonly used to manufacture tooling inserts for micro injection moulding and hot embossing, and thus to endure many thermal cycles.

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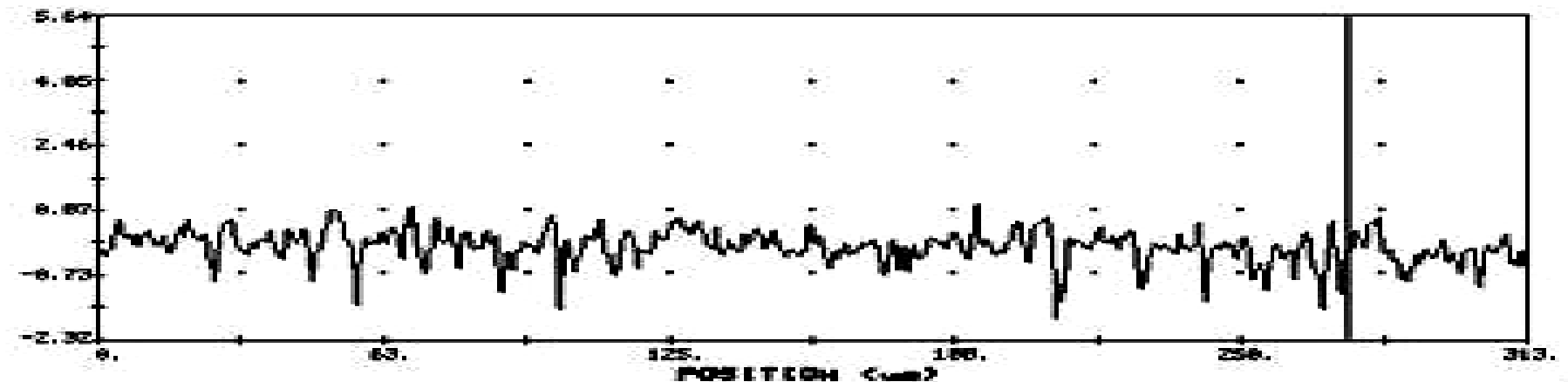
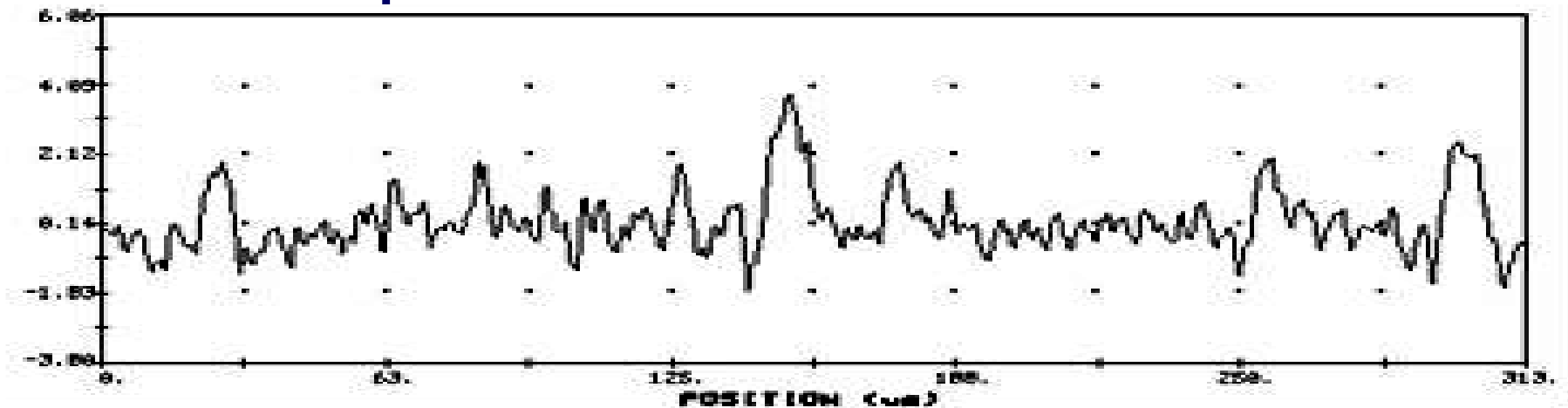


## Laser Sources:

Laser Source	Laser process parameters	Roughness achieved, Ra $\mu\text{m}$
Femtosecond Laser source SP Hurricane (amplified Ti:Sapphire) Wavelength = 800nm Rep. Rate = 5kHz Pulse = 130fs	Power = 20 mW Scanning Speed = 1.67 mm/s Number of passes = 4 Step = 0.01 mm Fluence = 0.25 J/cm <sup>2</sup>	0.35
Picosecond laser source – Stacatto (Lumera) Wavelength = 1064 nm Rep. Rate = 50 kHz Pulse = 12 ps	Power = 100 mW Scanning Speed = 100 mm/s Number of passes = 10 Step = 0.002 mm Fluence = 1.13 J/cm <sup>2</sup>	0.29



## Surface profile:



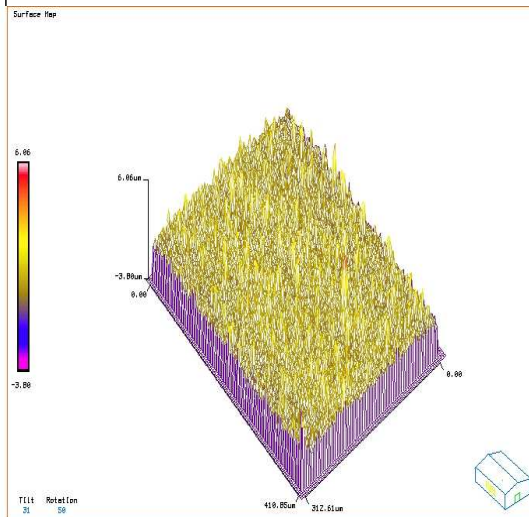
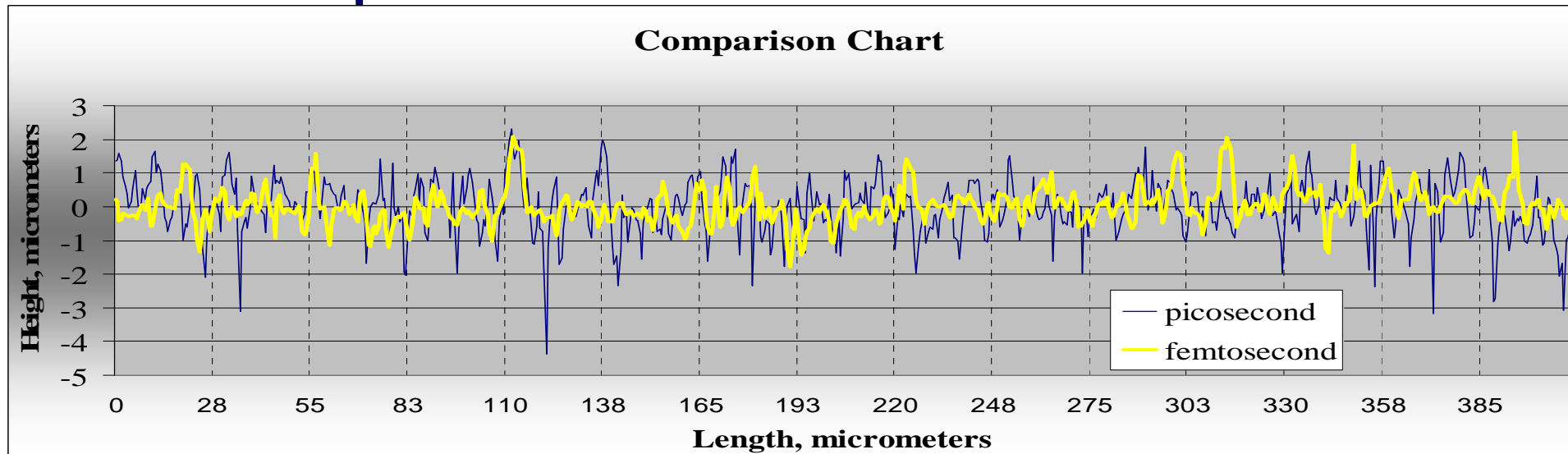
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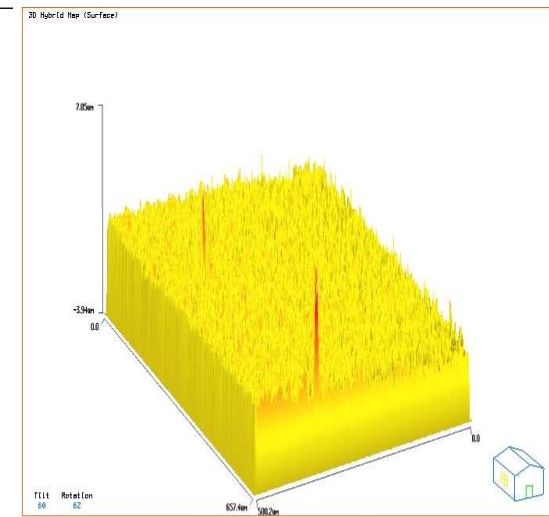


# Experiments & Results

## Surface profile:

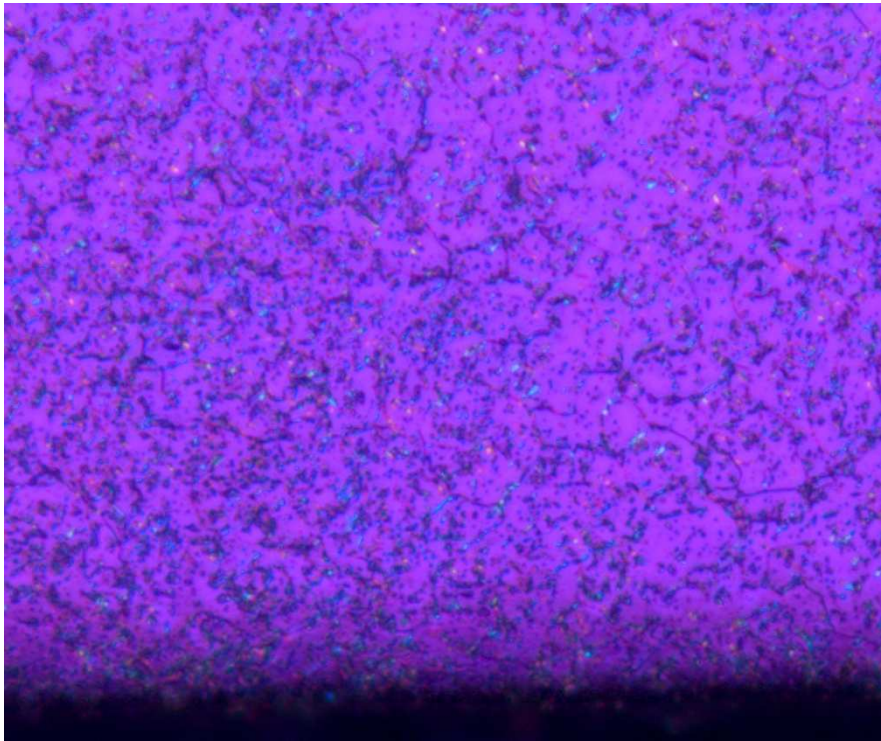


Best Roughness achieved:  
 <-Femtosecond source – 0.35  $\mu\text{m}$  Ra  
 Picosecond source – 0.29  $\mu\text{m}$  Ra ->

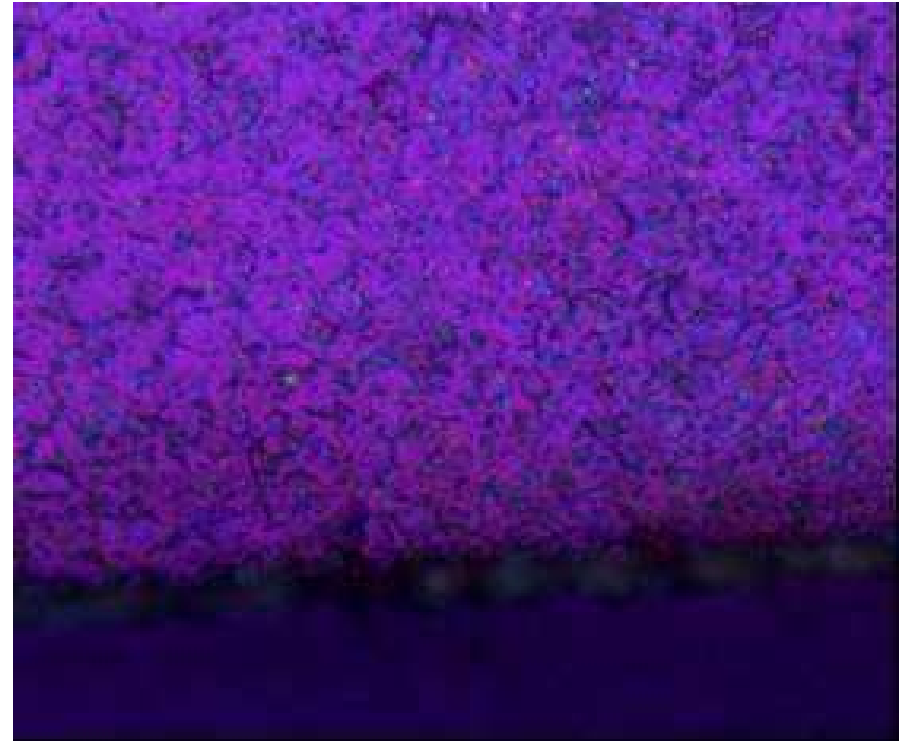


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## Microstructure



fs laser



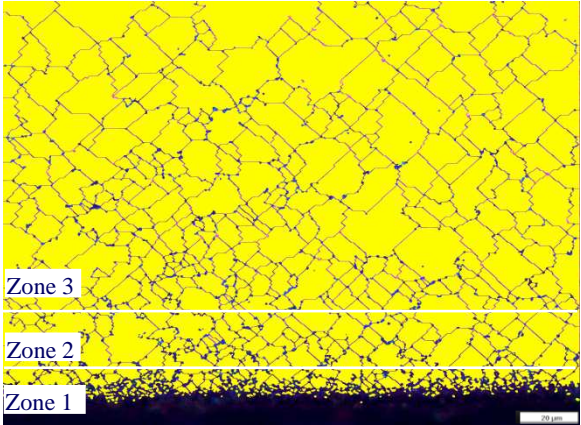
ps laser

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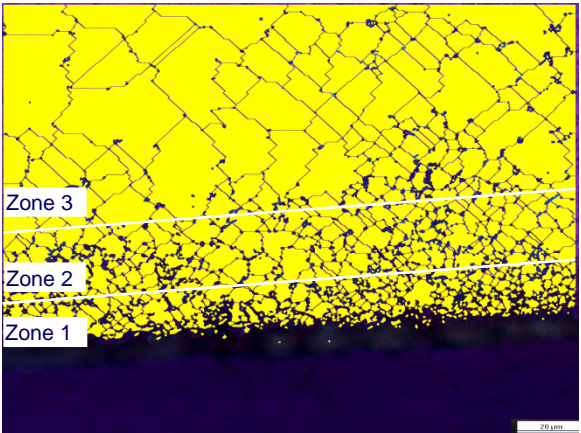


# Experiments & Results

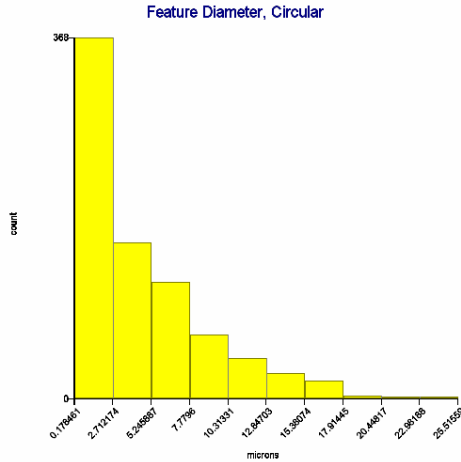
## Microstructure



fs laser



ps laser



**Field Summary**

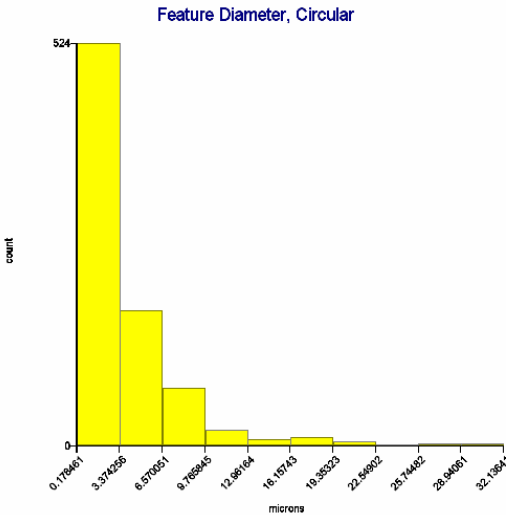
Bitplane(s):  
Feature

Statistics:  
 Min: 0.178461 μm  
 Max: 25.51559 μm  
 Mean: 4.52923 μm  
 Std Dev: 4.368767 μm  
 95% CI: 0.308341 μm  
 % RA: 6.807798 %

Field Information:  
 Field Area: 30016.43 μm²  
 Total Area: 30016.43 μm²  
 Field Count: 1

Object Information:  
 Object Count: 803  
 Data Points Over: 0  
 Data Points Under: 0  
 % Data Points Displayed: 100 %

**Zone 1 below 10 μm,  
 Zone 2 from 10 to 30μm  
 Zone 3 above 30 μm.**



**Field Summary**

Bitplane(s):  
Feature

Statistics:  
 Min: 0.178461 μm  
 Max: 32.13641 μm  
 Mean: 3.661427 μm  
 Std Dev: 3.993609 μm  
 95% CI: 0.278248 μm  
 % RA: 7.599438 %

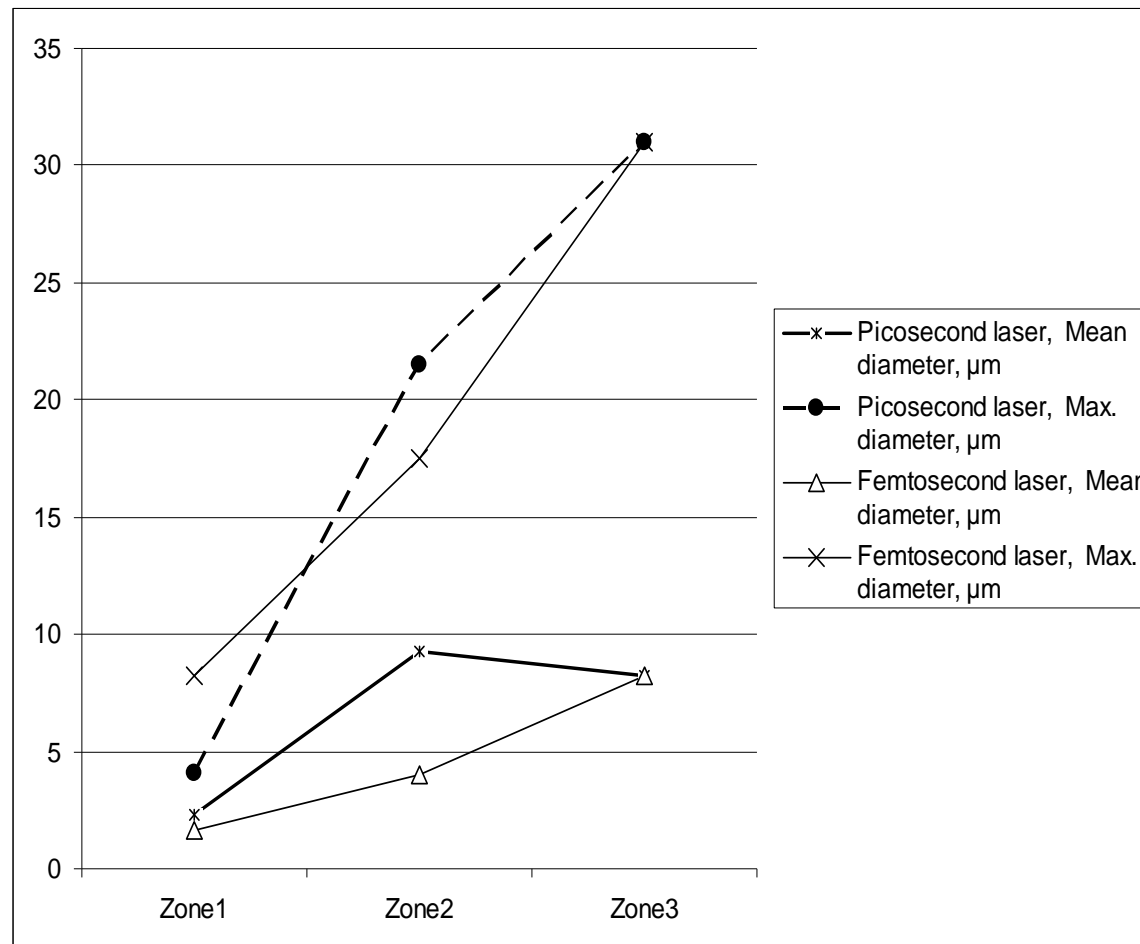
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 Total Area: 30016.43 μm²  
 Field Count: 1

Object Information:  
 Object Count: 824  
 Data Points Over: 0  
 Data Points Under: 0  
 % Data Points Displayed: 100 %

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## Microstructure



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-When performing ultra short pulsed laser ablation, some heat is transferred into the bulk, but it is not sufficient to trigger significant structural changes. Heat penetration is small and grain refinement is minimal. The effects of pulse duration on the resulting material microstructure are more evident in the micrograph of the field exposed to ps laser ablation than that of the area which underwent processing with fs laser pulses.

-In this research, a marginally better surface quality was achieved when performing laser milling with a ps laser source. This could be explained with nonlinear effects that are typical for processing materials at fs regimes, and also with the specific machining response of the tooling steel to the selected processing parameters, especially the laser's wavelength.

# THE END

Thank you !

The authors would like to thank Dr. Martyn Knowles and Dr. Dimitris Karnakis of Oxford Lasers, Steven Wheeler of Lumera, and Dr. Nadeem Rizvi of UK Laser Micromachining Centre for their help in conducting this experimental study.



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